



# Product Change Notification

**Change Notification #:** 117181 - 00  
**Change Title:** Intel® Enpirion® Power Solutions,  
PCN 117181-00, Documentation,  
Package Outline Drawing Update  
**Date of Publication:** September 27, 2019

## Key Characteristics of the Change:

Documentation

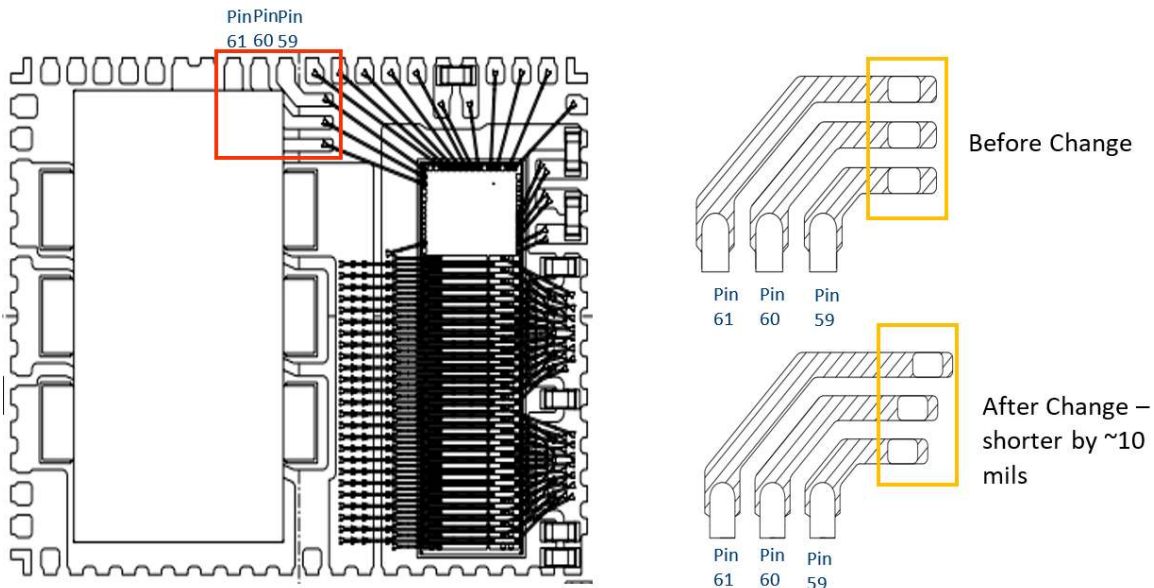
## Forecasted Key Milestones:

Availability of Intel® Enpirion® Power Solutions Datasheet Update:	September 27, 2019
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## Description of Change to the Customer:

The Intel Network & Custom Logic Group (formerly Programmable Solutions Group, Altera) is notifying customers of a Package Outline Drawing (POD) update on selected devices of Intel® Enpirion® Power Solutions.

This is to reflect the current exposed pads design in the POD. The following is the visual representation of the change.



Below are the links to the datasheets with the updated package drawing:

<b>Product</b>	<b>Updated Datasheet Link</b>
EV1380QI	<a href="https://www.intel.com/content/dam/www/programmable/us/en/pdfs/literature/ds/ev1380qi_08888.pdf">https://www.intel.com/content/dam/www/programmable/us/en/pdfs/literature/ds/ev1380qi_08888.pdf</a>
EN6360QI	<a href="https://www.intel.com/content/dam/www/programmable/us/en/pdfs/literature/ds/en6360qi_06489.pdf">https://www.intel.com/content/dam/www/programmable/us/en/pdfs/literature/ds/en6360qi_06489.pdf</a>
EN6360QA	<a href="https://www.intel.co.jp/content/dam/www/programmable/us/en/pdfs/literature/ds/en6360qa_10396.pdf">https://www.intel.co.jp/content/dam/www/programmable/us/en/pdfs/literature/ds/en6360qa_10396.pdf</a>

### **Customer Impact of Change and Recommended Action:**

No additional action required as there is no impact to the fit and function of the product and the affected pads are not electrically connected or soldered in the customer's board assembly process.

For questions or support, please contact your local Field Applications Engineer (FAE) or submit a service request at the [My Intel](#) support page.

### **Products Affected / Intel Ordering Codes:**

<b>Ordering Part Number</b>	<b>Product Code</b>	<b>S-Spec</b>	<b>MM#</b>
EN6360QI	POLLV4398	S R7SQ	969270
EN6360QA	POLLV4523	S R7W0	969379
EV1380QI	MEMTERM6596	S R9MS	971455

### **PCN Revision History:**

**Date of Revision:**  
September 27, 2019

**Revision Number:**  
00

**Reason:**  
Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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